Description

The 9ZXL1251 meets the demanding requirements of the Intel DB1200ZL specification, including the critical low-drift requirements of Intel CPUs. It is pin compatible to the 9ZXL1231 and integrates 24 termination resistors, saving 41mm² board area.

Applications

Buffer for Romley, Grantley and Purley Servers, solid state storage and PCIe

Output Features

 12 LP-HCSL Output Pairs w/integrated terminations (Zo = 85Ω)

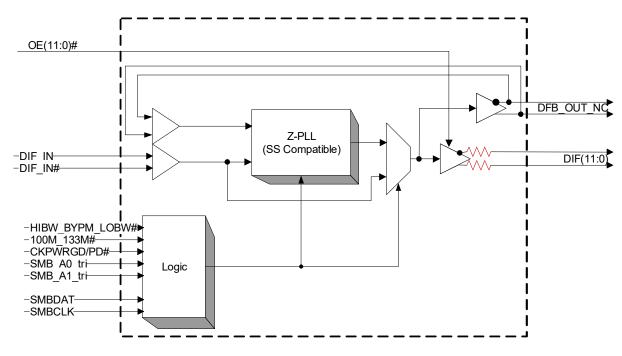
Key Specifications

- Cycle-to-cycle jitter < 50ps
- Output-to-output skew < 50ps
- Input-to-output delay variation < 50ps
- PCIe Gen3 phase jitter < 1.0ps RMS
- Phase jitter: QPI/UPI > = 9.6GB/s < 0.2ps rms

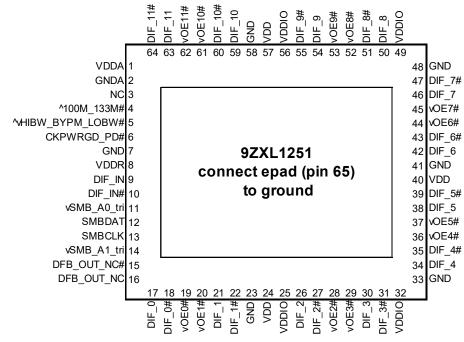
Block Diagram

Features

- 25MHz PFT clock delay management
- 85Ω Low-power push-pull HCSL outputs; eliminate 24 resistors, save $41mm^2$ of area
- Pin compatible to 9ZX21201 and 9ZXL1231; easy path to power and area savings
- Space-saving 64-pin VFQFPN package
- · Fixed feedback path for 0ps input-to-output delay
- 9 selectable SMBus addresses; multiple devices can share the same SMBus segment
- 12 OE# pins; hardware control of each output
- PLL or bypass mode; supports common and separate clock architectures
- Selectable PLL bandwidth; minimizes jitter peaking in downstream PLLs
- Spread spectrum compatible; tracks spreading input clock for low EMI
- -40°C to +85°C device available; supports demanding environmental applications



Pin Configuration



9 x 9mm VFQFPN package

Note: Pins with ^ prefix have internal 120K pullup Pins with v prefix have internal 120K pulldowm Pins with ^v prefix have internal 120K pullup/pulldown (biased to VDD/2)

Power Management Table

| CKPWRGD_PD# | DIF_IN/ DIF_IN# | SMBus EN bit | DIF(11:0)/ DIF(11:0)# | PLL STATE IF NOT IN BYPASS MODE |
|-------------|--------------------|-----------------|--------------------------|--|
| 0 | Х | Х | Low/Low | OFF |
| 1 | Bunning | 0 | Low/Low | ON |
| | Running | 1 | Running | ON |

Functionality at Power-up (PLL mode)

| 100M_133M# | DIF_IN MHz | DIF(11:0) |
|------------|---------------|-----------|
| 1 | 100.00 | DIF_IN |
| 0 | 133.33 | DIF_IN |

Power Connections

| | Pin Number | | |
|----------|-------------|-----------------------|--------------|
| VDD | VDDIO | GND | Description |
| 1 | | 2 | Analog PLL |
| 8 | | 7 | Analog Input |
| 24,40,57 | 25,32,49,56 | 23,33,41,48, 58,65 | DIF clocks |

PLL Operating Mode Readback Table

| HiBW_BypM_LoBW# | Byte0, bit 7 | Byte 0, bit 6 |
|-----------------|--------------|---------------|
| Low (Low BW) | 0 | 0 |
| Mid (Bypass) | 0 | 1 |
| High (High BW) | 1 | 1 |

PLL Operating Mode

| HiBW_BypM_LoBW# | MODE |
|-----------------|-----------|
| Low | PLL Lo BW |
| Mid | Bypass |
| High | PLL Hi BW |
| | |

NOTE: PLL is OFF in Bypass Mode

9ZXL1251 SMBus Addressing

| P | Pin | |
|------------|------------|---------------|
| SMB_A1_tri | SMB_A0_tri | SMBus Address |
| 0 | 0 | D8 |
| 0 | М | DA |
| 0 | 1 | DE |
| М | 0 | C2 |
| М | М | C4 |
| М | 1 | C6 |
| 1 | 0 | CA |
| 1 | М | CC |
| 1 | 1 | CE |

Pin Descriptions

| PIN # | PIN NAME | TYPE | DESCRIPTION |
|-------|-------------------|---------|--|
| 1 | VDDA | PWR | Power for the PLL core. |
| 2 | GNDA | GND | Ground pin for the PLL core. |
| 3 | NC | N/A | No Connection. |
| 4 | ^100M_133M# | IN | 3.3V Input to select operating frequency. This pin has an internal pull-up resistor. See Functionality Table for Definition |
| - | | LATCHED | Trilevel input to select High BW, Bypass or Low BW mode. This pin is biased to VDD/2 |
| 5 | ^vHIBW_BYPM_LOBW# | IN | (Bypass mode) with internal pull up/pull down resistors. See PLL Operating Mode Table for |
| 6 | CKPWRGD_PD# | IN | 3.3V Input notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on subsequent assertions. Low enters Power Down Mode. |
| 7 | GND | GND | Ground pin. |
| 8 | VDDR | PWR | 3.3V power for differential input clock (receiver). This VDD should be treated as an analog power rail and filtered appropriately. |
| 9 | DIF IN | IN | HCSL True input |
| - | DIF IN# | IN | HCSL Complementary Input |
| | vSMB_A0_tri | IN | SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A1 to decode 1 of 9 SMBus Addresses. It has an internal 120Kohm pull down resistor. |
| 12 | SMBDAT | I/O | Data pin of SMBUS circuitry, 5V tolerant |
| - | SMBCLK | IN | Clock pin of SMBUS circuitry, 5V tolerant |
| | vSMB_A1_tri | IN | SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A0 to decode 1 of 9 SMBus Addresses. It has an internal 120Kohm pull down resistor. |
| 15 | DFB_OUT_NC# | OUT | Complementary half of differential feedback output, provides feedback signal to the PLL for synchronization with input clock to eliminate phase error. This pin should NOT be connected on the circuit board, the feedback is internal to the package. |
| 16 | DFB_OUT_NC | OUT | True half of differential feedback output, provides feedback signal to the PLL for synchronization with the input clock to eliminate phase error. This pin should NOT be connected on the circuit board, the feedback is internal to the package. |
| 17 | DIF_0 | OUT | HCSL true clock output |
| 18 | DIF_0# | OUT | HCSL Complementary clock output |
| 19 | vOE0# | IN | Active low input for enabling DIF pair 0. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 20 | vOE1# | IN | Active low input for enabling DIF pair 1. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 21 | DIF 1 | OUT | HCSL true clock output |
| 22 | DIF_1# | OUT | HCSL Complementary clock output |
| 23 | GND | GND | Ground pin. |
| 24 | VDD | PWR | Power supply, nominal 3.3V |
| 25 | VDDIO | PWR | Power supply for differential outputs |
| 26 | DIF_2 | OUT | HCSL true clock output |
| 27 | DIF_2# | OUT | HCSL Complementary clock output |
| 28 | vOE2# | IN | Active low input for enabling DIF pair 2. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 29 | vOE3# | IN | Active low input for enabling DIF pair 3. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 30 | DIF 3 | OUT | HCSL true clock output |
| 31 | DIF 3# | OUT | HCSL Complementary clock output |
| | VDDIO | PWR | Power supply for differential outputs |
| | GND | GND | Ground pin. |
| | DIF 4 | OUT | HCSL true clock output |
| | DIF_4# | OUT | HCSL Complementary clock output |
| | vOE4# | IN | Active low input for enabling DIF pair 4. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |
| 37 | vOE5# | IN | Active low input for enabling DIF pair 5. This pin has an internal pull-down. 1 =disable outputs, 0 = enable outputs |

Pin Descriptions (cont.)

| | PIN NAME | TYPE | DESCRIPTION |
|------|-------------|------|--|
| 38 I | DIF_5 | OUT | HCSL true clock output |
| 39 I | DIF_5# | OUT | HCSL Complementary clock output |
| 40 | VDD | PWR | Power supply, nominal 3.3V |
| 41 (| GND | GND | Ground pin. |
| 42 I | DIF_6 | OUT | HCSL true clock output |
| 43 I | DIF_6# | OUT | HCSL Complementary clock output |
| 44 | vOE6# | IN | Active low input for enabling DIF pair 6. This pin has an internal pull-down. |
| 44 | VUE0# | IIN | 1 =disable outputs, 0 = enable outputs |
| 45 | VOE7# | IN | Active low input for enabling DIF pair 7. This pin has an internal pull-down. |
| 45 v | vOE7# | IIN | 1 =disable outputs, 0 = enable outputs |
| 46 I | DIF_7 | OUT | HCSL true clock output |
| 47 1 | DIF_7# | OUT | HCSL Complementary clock output |
| 48 (| GND | GND | Ground pin. |
| 49 | VDDIO | PWR | Power supply for differential outputs |
| 50 I | DIF 8 | OUT | HCSL true clock output |
| 51 I | DIF_8# | OUT | HCSL Complementary clock output |
| 50 | | INI | Active low input for enabling DIF pair 8. This pin has an internal pull-down. |
| 52 v | vOE8# | IN | 1 =disable outputs, 0 = enable outputs |
| 50 | | INI | Active low input for enabling DIF pair 9. This pin has an internal pull-down. |
| 53 v | vOE9# | IN | 1 =disable outputs, 0 = enable outputs |
| 54 I | DIF_9 | OUT | HCSL true clock output |
| 55 I | DIF_9# | OUT | HCSL Complementary clock output |
| 56 | VDDIO | PWR | Power supply for differential outputs |
| 57 | VDD | PWR | Power supply, nominal 3.3V |
| 58 0 | GND | GND | Ground pin. |
| 59 I | DIF_10 | OUT | HCSL true clock output |
| 60 I | DIF_10# | OUT | HCSL Complementary clock output |
| C1 . | OF40# | INI | Active low input for enabling DIF pair 10. This pin has an internal pull-down. |
| 61 v | vOE10# | IN | 1 =disable outputs, 0 = enable outputs |
| 60 | VOE11# | INI | Active low input for enabling DIF pair 11. This pin has an internal pull-down. |
| 62 \ | vOE11# | IN | 1 =disable outputs, 0 = enable outputs |
| 63 I | DIF_11 | OUT | HCSL true clock output |
| | DIF_11# | OUT | HCSL Complementary clock output |
| | epad | GND | epad, connect to ground |

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 9ZXL1251. These ratings, which are standard values for Renesas commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|----------------------|-----------------|----------------------------|---------|-----|----------------------|-------|-------|
| Supply Voltage | VDDx | | | | 4.6 | V | 1,2 |
| Input Low Voltage | V _{IL} | | GND-0.5 | | | V | 1 |
| Input High Voltage | V _{IH} | Except for SMBus interface | | | V _{DD} +0.5 | V | 1,3 |
| Input High Voltage | VIHSMB | SMBus clock and data pins | | | 5.5 | V | 1 |
| Storage Temperature | Ts | | -65 | | 150 | °C | 1 |
| Junction Temperature | Tj | | | | 125 | °C | 1 |
| Input ESD protection | ESD prot | Human Body Model | 2000 | | | V | 1 |

¹Guaranteed by design and characterization, not 100% tested in production.

² Operation under these conditions is neither implied nor guaranteed.

³ Not to exceed 4.6V.

Electrical Characteristics–DIF_IN Clock Input Parameters

T_{AMB} = T_{COM} or T_{IND}, unless noted., Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|-------------------------------------|--------------------|--|-----|-----|-----|-------|-------|
| Input Crossover Voltage - DIF_IN | V _{CROSS} | Crossover Voltage | 150 | | 900 | mV | 1 |
| Input Swing - DIF_IN | V _{SWING} | Differential value | 300 | | | mV | 1 |
| Input Slew Rate - DIF_IN | dv/dt | Measured differentially | 0.4 | | 8 | V/ns | 1,2 |
| Input Leakage Current | I _{IN} | $V_{IN} = V_{DD}$, $V_{IN} = GND$ | -5 | | 5 | uA | |
| Input Duty Cycle | d _{tin} | Measurement from differential waveform | 45 | | 55 | % | 1 |
| Input Jitter - Cycle to Cycle | J _{DIFIn} | Differential Measurement | 0 | | 125 | ps | 1 |

¹ Guaranteed by design and characterization, not 100% tested in production.

² Slew rate measured through +/-75mV window centered around differential zero.

Electrical Characteristics-SMBus

T_{AMB} = T_{COM} or T_{IND}, unless noted., Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| | | | | - | | | |
|------------------------------|---------------------|--------------------------------------|-----|-----|--------------------|-------|-------|
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
| SMBus Input Low Voltage | VILSMB | | | | 0.8 | V | |
| SMBus Input High Voltage | VIHSMB | | 2.1 | | V _{DDSMB} | V | |
| SMBus Output Low Voltage | V _{OLSMB} | At I _{PULLUP} | | | 0.4 | V | |
| SMBus Sink Current | I _{PULLUP} | At V _{OL} | 4 | | | mA | |
| Nominal Bus Voltage | V _{DDSMB} | | 2.7 | | 3.6 | V | 1 |
| SCLK/SDATA Rise Time | t _{RSMB} | (Max VIL - 0.15) to (Min VIH + 0.15) | | | 1000 | ns | 1 |
| SCLK/SDATA Fall Time | t _{FSMB} | (Min VIH + 0.15) to (Max VIL - 0.15) | | | 300 | ns | 1 |
| SMBus Operating Frequency | f _{MAXSMB} | Maximum SMBus operating frequency | | | 400 | kHz | 5 |

¹ Guaranteed by design and characterization, not 100% tested in production.

² Control input must be monotonic from 20% to 80% of input swing.

³ Time from deassertion until outputs are > 200mV.

⁴ DIF_IN input.

⁵ The differential input clock must be running for the SMBus to be active.

Electrical Characteristics–Input/Supply/Common Parameters

T_{AMB} = T_{COM} or T_{IND}, unless noted., Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | | NOTES |
|-----------------------|------------------------|---|-----------|--------|-----------------------|---|-------|
| Supply Voltage | VDDx | Supply voltage, except VDDIO | 3.135 | 3.3 | 3.465 | V | |
| Output Supply Voltage | VDDIO | Supply voltage for DIF outputs, if present | 0.95 | 1.05 | 3.465 | | |
| Ambient Operating | T _{AMB} | Commercial range (T _{COM}) | 0 | | 70 | - | |
| Temperature | ' AMB | Industrial range (T _{IND}) | -40 | | 85 | °C | |
| Input High Voltage | V _{IH} | Single-ended inputs, except SMBus, tri-level inputs | 2 | | V _{DD} + 0.3 | V | |
| Input Low Voltage | V _{IL} | Single-ended inputs, except SMBus, tri-level inputs | GND - 0.3 | | 0.8 | V | |
| Input High Voltage | V _{IHTRI} | Tri-Level Inputs | 2.2 | | V _{DD} + 0.3 | V | |
| Input Mid Voltage | V _{IMTRI} | Tri-Level Inputs | 1.2 | VDD/2 | 1.8 | V | |
| Input Low Voltage | V _{ILTRI} | Tri-Level Inputs | GND - 0.3 | | 0.8 | V | |
| | I _{IN} | Single-ended inputs, V_{IN} = GND, V_{IN} = VDD | -5 | | 5 | uA | |
| | | Single-ended inputs | | | | | |
| Input Current | I _{INP} | $V_{IN} = 0 V$; Inputs with internal pull-up resistors | -200 | | 200 | uA | |
| | | V _{IN} = VDD; Inputs with internal pull-down resistors | | | | 3.465 V 70 °C 85 °C p+0.3 V 0.8 V 0.8 V 200 uA 150 MHz 110 MHz 147 MHz 7 nH 5 pF 2.7 pF 6 pF 1.8 ms 33 kHz 10 clocks 300 us | |
| | F _{ibyp} | V _{DD} = 3.3 V, Bypass mode | 25 | | 150 | MHz | |
| Input Frequency | F _{ipll} | V _{DD} = 3.3 V, 100MHz PLL mode | 25 | 100.00 | 110 | MHz | |
| | F _{ipll} | V _{DD} = 3.3 V, 133.33MHz PLL mode | 120 | 133.33 | 147 | MHz | |
| Pin Inductance | L _{pin} | | | | 7 | nH | 1 |
| | C _{IN} | Logic Inputs, except DIF_IN | 1.5 | | 5 | pF | 1 |
| Capacitance | C _{INDIF_IN} | DIF_IN differential clock inputs | 1.5 | | 2.7 | pF | 1,4 |
| | C _{OUT} | Output pin capacitance | | | 6 | pF | 1 |
| Clk Stabilization | - - | From V _{DD} Power-Up and after input clock | | 0.18 | 1.0 | | 10 |
| CIK Stabilization | T _{STAB} | stabilization or de-assertion of PD# to 1st clock | | 0.10 | 1.0 | ms | 1,2 |
| Input SS Modulation | f _{MODINPCIe} | Allowable Frequency for PCle Applications | 30 | | 33 | kHz | |
| Frequency PCle | MODINPCIE | (Triangular Modulation) | | | | | |
| OE# Latency | t _{LATOE} # | DIF start after OE# assertion DIF stop after OE# deassertion | 4 | | 10 | clocks | 1,2,3 |
| Tdrive_PD# | t _{DRVPD} | DIF output enable after PD# de-assertion | | | 300 | us | 1,3 |
| Tfall | t _F | Fall time of control inputs | | | 5 | ns | 2 |
| Trise | t _R | Rise time of control inputs | | | 5 | ns | 2 |

¹ Guaranteed by design and characterization, not 100% tested in production.

² Control input must be monotonic from 20% to 80% of input swing.

³ Time from deassertion until outputs are > 200mV.

⁴ DIF_IN input.

Electrical Characteristics–DIF Low Power HCSL Outputs

T_{AMB} = T_{COM} or T_{IND}, unless noted., Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| | | | | | 0 | | |
|------------------------|------------|--|------|-----|------|-------|-------|
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
| Slew rate | te dV/dt | T _{AMB} = T _{COM} , Scope averaging on | 1.6 | 3.3 | 4 | V/ns | 1,2,3 |
| Siew late | uv/ut | T _{AMB} = T _{IND} Scope averaging on | 1.6 | 2.8 | 4.1 | V/ns | 1,2,3 |
| Slew rate matching | ∆dV/dt | Slew rate matching, Scope averaging on | | 7 | 20 | % | 1,2,4 |
| Voltage High | VHigh | Statistical measurement on single-ended signal | 660 | 754 | 850 | mV | |
| Voltage Low | VLow | using oscilloscope math function. (Scope averaging on) -150 62 15 | | 150 | | | |
| Max Voltage | Vmax | Measurement on single ended signal using | | 868 | 1150 | mV | |
| Min Voltage | Vmin | absolute value. (Scope averaging off) | -300 | -64 | | IIIV | |
| Crossing Voltage (abs) | Vcross_abs | Scope averaging off | 250 | 453 | 550 | mV | 1,5 |
| Crossing Voltage (var) | ∆-Vcross | Scope averaging off | | 17 | 140 | mV | 1,6 |

¹Guaranteed by design and characterization, not 100% tested in production.

² Measured from differential waveform.

³ Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

⁴ Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

⁵ Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

⁶ The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting Δ-Vcross to be smaller than Vcross absolute.

⁷ At default SMBus settings.

Electrical Characteristics–Current Consumption

T_{AMB} = T_{COM} or T_{IND}, unless noted., Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|-------------------|--------------------------------------|-----|------|-----|-------|-------|
| | | VDDA, PLL Mode@100MHz | | 13.4 | 20 | mA | 1 |
| Operating Supply Current | I _{DDA} | VDDA, PLL Bypass Mode@100MHz | | 4.8 | 8 | mA | 1 |
| | I _{DD} | All other VDD pins | | 16 | 25 | mA | |
| | I _{DDIO} | VDDIO for DIF outputs, if applicable | | 81 | 95 | mA | |
| | I _{DDA} | VDDA, PLL Mode@100MHz | | 3 | 5 | mA | 1 |
| Davier Davie Current | | VDDA, PLL Bypass Mode@100MHz | | 3 | 5 | mA | 1 |
| Power Down Current | I _{DD} | All other VDD pins | | 0.14 | 1 | mA | |
| | I _{DDIO} | VDDIO for DIF outputs, if applicable | | 0.01 | 0.3 | mA | |

^{1.} Includes VDDR if applicable

Electrical Characteristics–Skew and Differential Jitter Parameters

| T T T | | | er normal operation conditions | • • • • • • • • • • • • • • • • • • • | $\mathbf{I} = \mathbf{I} + $ |
|---------------|---------------------------|------------------|--------------------------------|---------------------------------------|--|
| | | unniv voitade ne | ar normal operation conditions | | |
| | <i>i</i> iiicaa iicicu Ot | | | | |
| | | | | | |

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|---|------------------------|--|------|------|-----|---|-----------|
| CLK_IN, DIF[x:0] | t _{SPO_PLL} | Input-to-Output Skew in PLL mode @100MHz, nominal temperature and voltage | -100 | 3 | 100 | ps | 1,2,4,5,8 |
| CLK_IN, DIF[x:0] | t _{PD_BYP} | Input-to-Output Skew in Bypass mode @100MHz, nominal temperature and voltage | 2.5 | 3.6 | 4.5 | ns | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSPO_PLL} | Input-to-Output Skew Variation in PLL mode @100MHz, across voltage and temperature | -50 | 0 | 50 | ps | 1,2,3,5,8 |
| | + | Input-to-Output Skew Variation in Bypass mode @100MHz, across voltage and temperature, T _{AMB} = T _{COM} | -250 | | 250 | ps | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{dspo_byp} | Input-to-Output Skew Variation in Bypass mode @100MHz, across voltage and temperature, T _{AMB} = T _{IND} | -350 | | 350 | ps | 1,2,3,5,8 |
| DIF[x:0] | + | Output-to-Output Skew across all outputs @100MHz, T _{AMB} = T _{COM} | | 36 | 50 | ps | 1,2,3,8 |
| Dii [X.0] | t _{skew_all} | Output-to-Output Skew across all outputs @100MHz, T _{AMB} = T _{IND} | | 38 | 65 | ps 1 ps 1 ps dB dB dB MHz MHz | 1,2,3,8 |
| PLL Jitter Peaking | j _{peak-hibw} | LOBW#_BYPASS_HIBW = 1 | 0 | 1.2 | 2.5 | dB | 7,8 |
| PLL Jitter Peaking | j _{peak-lobw} | LOBW#_BYPASS_HIBW = 0 | 0 | 0.8 | 2 | dB | 7,8 |
| PLL Bandwidth | рІІ _{НІВW} | LOBW#_BYPASS_HIBW = 1 | 2 | 3 | 4 | MHz | 8,9 |
| PLL Bandwidth | pll _{LOBW} | LOBW#_BYPASS_HIBW = 0 | 0.7 | 1.1 | 1.4 | MHz | 8,9 |
| Duty Cycle | t _{DC} | Measured differentially, PLL Mode | 45 | 50 | 55 | % | 1 |
| Duty Cycle Distortion | t _{DCD} | Measured differentially, Bypass Mode @100MHz | -1.5 | -0.6 | 0 | % | 1,10 |
| Jitter, Cycle to cycle | t _{jcyc-cyc} | PLL mode | | 25 | 50 | ps | 1,11 |
| , - <u>,</u> <u>,</u> <u>,</u> <u>,</u> <u>,</u> <u>,</u> | JCy C-Cy C | Additive Jitter in Bypass Mode | | 1 | 5 | ps | 1,11 |

Notes for preceding table:

¹ Measured into fixed 2pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

² Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

³ All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

⁴ This parameter is deterministic for a given device.

⁵ Measured with scope averaging on to find mean value.

⁶ t is the period of the input clock.

⁷ Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

^{8.} Guaranteed by design and characterization, not 100% tested in production.

⁹ Measured at 3 db down or half power point.

¹⁰ Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

Electrical Characteristics–Phase Jitter Parameters

T_{AMB} = T_{COM} or T_{IND}, unless noted., Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | IND.LIMIT | UNITS | Notes |
|---|-------------------------|--|-----|------|------|-----------|-------------|---------|
| | t _{jphPCIeG1} | PCle Gen 1 | | 36 | 49 | 86 | ps (p-p) | 1,2,3 |
| | t _{jphPC1eG2} | PCle Gen 2 Lo Band 10kHz < f < 1.5MHz | | 1.2 | 1.6 | 3 | ps (rms) | 1,2 |
| Phase Jitter, PLL Mode | | PCle Gen 2 High Band 1.5MHz < f < Nyquist (50MHz) | | 2.2 | 2.8 | 3.1 | ps (rms) | 1,2 |
| | t _{jphPCIeG3} | PCle Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz) | | 0.56 | 0.63 | 1 | ps (rms) | 1,2,4 |
| | t _{jphQPI_SMI} | QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI) | | 0.22 | 0.48 | 0.5 | ps (rms) | 1,4 |
| | | QPI & SMI (100MHz, 8.0Gb/s, 12UI) | | 0.15 | 0.28 | 0.3 | ps (rms) | 1,4 |
| | | QPI & SMI (100MHz, 9.6Gb/s, 12UI) | | 0.11 | 0.17 | 0.2 | ps (rms) | 1,4 |
| | t _{jphPCIeG1} | PCle Gen 1 | | 0.0 | 0.8 | n/a | ps (p-p) | 1,2,3 |
| | | PCle Gen 2 Lo Band 10kHz < f < 1.5MHz | | 0.1 | 0.2 | n/a | ps (rms) | 1,2,5 |
| | t _{jphPC1eG2} | PCle Gen 2 High Band 1.5MHz < f < Nyquist (50MHz) | | 0.4 | 0.5 | n/a | ps (rms) | 1,2,5 |
| <i>Additiv</i> e Phase Jitter, Bypass mode | t _{jphPC1eG3} | PCle Gen 3 (PLL BW of 2-4 or 2-5 MHz, CDR = 10MHz) | | 0.0 | 0.0 | n/a | ps (rms) | 1,2,4,5 |
| | | QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI) | | 0.11 | 0.2 | n/a | ps (rms) | 1,4,5 |
| | t _{jphQPI_SMI} | QPI & SMI (100MHz, 8.0Gb/s, 12UI) | | 0.00 | 0.01 | n/a | ps (rms) | 1,4,5 |
| | | QPI & SMI (100MHz, 9.6Gb/s, 12UI) | | 0.00 | 0.01 | n/a | ps (rms) | 1,4,5 |

¹ Applies to all outputs.

² See http://www.pcisig.com for complete specs.

³ Sample size of at least 100K cycles. This figure extrapolates to 108ps pk-pk at 1M cycles for a BER of 1⁻¹².

⁴ Calculated from Intel-supplied Clock Jitter Tool v1.6.3.

⁵ For RMS figures, additive jitter is calculated by solving the following equation: Additive jitter = SQRT[(total jitter)² - (input jitter)²]

Clock Periods–Differential Outputs with Spread Spectrum Disabled

| | | | | Ν | Measurement | Window | | | | |
|---------|----------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
| | Contor | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
| SSC OFF | F Freq. MHz | -c2c jitter AbsPer Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c jitter AbsPer Max | Units | Notes |
| DIF | 100.00 | 9.94900 | | 9.99900 | 10.00000 | 10.00100 | | 10.05100 | ns | 1,2,3 |
| DIF | 133.33 | 7.44925 | | 7.49925 | 7.50000 | 7.50075 | | 7.55075 | ns | 1,2,4 |

Clock Periods–Differential Outputs with Spread Spectrum Enabled

| | | | | Ν | leasurement | Window | | | | |
|--------|--------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
| | Center | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
| SSC ON | Freq. MHz | -c2c jitter AbsPer Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c jitter AbsPer Max | Units | Notes |
| DIF | 99.75 | 9.94906 | 9.99906 | 10.02406 | 10.02506 | 10.02607 | 10.05107 | 10.10107 | ns | 1,2,3 |
| DIF | 133.00 | 7.44930 | 7.49930 | 7.51805 | 7.51880 | 7.51955 | 7.53830 | 7.58830 | ns | 1,2,4 |

Notes:

¹Guaranteed by design and characterization, not 100% tested in production.

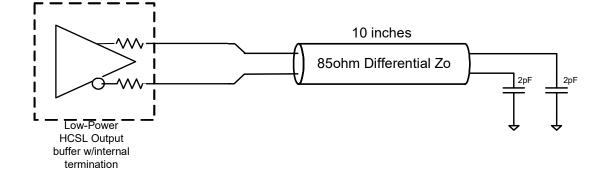
² All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 9ZXL1251 itself does not contribute to ppm error.

³ Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

⁴ Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode

Differential Output Terminations

| DIF Zo (Ω) | Rs (Ω) |
|------------|--------|
| 100 | NA |
| 85 | 0 |



General SMBus Serial Interface Information for 9ZXL1251

How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- Renesas clock will acknowledge
- Controller (host) sends the beginning byte location = N
- Renesas clock will **acknowledge**
- Controller (host) sends the byte count = X
- Renesas clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- Renesas clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

| | Index Blo | ock \ | Write Operation |
|--------------|------------|--------|--------------------------|
| Controller (| Host) | | Renesas (Slave/Receiver) |
| Т | starT bit | | |
| Slave A | Address | | |
| WR | WRite | | |
| | | | ACK |
| Beginning | g Byte = N | | |
| | | | ACK |
| Data Byte | Count = X | | |
| | | | ACK |
| Beginnin | ng Byte N | | |
| | | | ACK |
| 0 | | × | |
| 0 | | X Byte | 0 |
| 0 | | e | 0 |
| | | | 0 |
| Byte N | + X - 1 |] | |
| | | | ACK |
| Р | stoP bit | | |

How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- Renesas clock will acknowledge
- Controller (host) sends the beginning byte location = N
- Renesas clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- Renesas clock will acknowledge
- Renesas clock will send the data byte count = X
- Renesas clock sends Byte N+X-1
- Renesas clock sends Byte 0 through Byte X (if X_(H) was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| | Index Block R | lead C | Operation |
|------|-----------------|--------|-------------------|
| Co | ntroller (Host) | | Renesas |
| Т | starT bit | | |
| SI | ave Address | | |
| WR | WRite | | |
| | | - | ACK |
| Begi | nning Byte = N | - | |
| | | - | ACK |
| RT | Repeat starT | - | |
| SI | ave Address | | |
| RD | ReaD | | |
| | | | ACK |
| | | | |
| | | | Data Byte Count=X |
| | ACK | | |
| | | | Beginning Byte N |
| | ACK | | |
| | | e | 0 |
| | 0 | X Byte | 0 |
| | 0 | × | 0 |
| | 0 | | |
| | | | Byte N + X - 1 |
| N | Not acknowledge | | |
| Р | stoP bit | | |

SMBusTable: PLL Mode, and Frequency Select Register

| Byte | 0 Pin # | Name | Control Function | Туре | 0 | 1 | Default | | |
|-------|---------|------------|------------------------------|------|------------|------------------------|---------|--|--|
| Bit 7 | 5 | PLL Mode 1 | PLL Operating Mode Rd back 1 | R | See PLL Op | See PLL Operating Mode | | | |
| Bit 6 | 5 | PLL Mode 0 | PLL Operating Mode Rd back 0 | R | Readba | Latch | | | |
| Bit 5 | | | Reserved | | | | | | |
| Bit 4 | | | Reserved | | | | | | |
| Bit 3 | | PLL_SW_EN | Enable S/W control of PLL BW | RW | HW Latch | SMBus Control | 0 | | |
| Bit 2 | | PLL Mode 1 | PLL Operating Mode 1 | RW | See PLL Op | erating Mode | 1 | | |
| Bit 1 | | PLL Mode 0 | PLL Operating Mode 1 | RW | Readba | 1 | | | |
| Bit 0 | 4 | 100M_133M# | Frequency Select Readback | R | 133MHz | 100MHz | Latch | | |

Note: Setting bit 3 to '1' allows the user to override the Latch value from pin 5 via use of bits 2 and 1. Use the values from the PLL Operating Mode Readback Table. Note that Bits 7 and 6 will keep the value originally latched on pin 5. A warm reset of

SMBusTable: Output Control Register

| Byte | 1 Pin # | Name | Control Function | Туре | 0 | 1 | Default |
|-------|---------|----------|--|------|---------|--------|---------|
| Bit 7 | 47/46 | DIF_7_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 6 | 43/42 | DIF_6_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 5 | 39/38 | DIF_5_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 4 | 35/34 | DIF_4_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 |
| Bit 3 | 30/31 | DIF_3_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 2 | 26/27 | DIF_2_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 1 | 21/22 | DIF_1_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 0 | 17/18 | DIF_0_En | Output Control - '0' overrides OE# pin | RW | | | 1 |

SMBusTable: Output Control Register

| Byte | 2 | Pin # | Name | Control Function | Туре | 0 | 1 | Default |
|-------|----|----------|-----------|--|------|---------|--------|---------|
| Bit 7 | | Reserved | | | | | 0 | |
| Bit 6 | | Reserved | | | | | 0 | |
| Bit 5 | | | Reserved | | | | 0 | |
| Bit 4 | | | Reserved | | | | | 0 |
| Bit 3 | 64 | /63 | DIF_11_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 2 | 59 | 9/60 | DIF_10_En | Output Control - '0' overrides OE# pin | RW | Low/Low | Enable | 1 |
| Bit 1 | 54 | /55 | DIF_9_En | Output Control - '0' overrides OE# pin | RW | | | 1 |
| Bit 0 | 50 |)/51 | DIF_8_En | Output Control - '0' overrides OE# pin | RW | | | 1 |

SMBusTable: Reserved Register

| Byte 3 | Pin # | Name | Control Function | Туре | 0 | 1 | Default |
|--------|-------|----------|------------------|------|---|---|---------|
| Bit 7 | | | Reserved | | | | 0 |
| Bit 6 | | Reserved | | | | | |
| Bit 5 | | Reserved | | | | | 0 |
| Bit 4 | | Reserved | | | | | 0 |
| Bit 3 | | Reserved | | | | | 0 |
| Bit 2 | | | Reserved | | | | 0 |
| Bit 1 | | | Reserved | | | | 0 |
| Bit 0 | | | Reserved | | | | 0 |

SMBusTable: Reserved Register

| Byte 4 | 4 | Pin # | Name | Control Function | Туре | 0 | 1 | Default |
|--------|---|-------|----------|------------------|------|---|---|---------|
| Bit 7 | | | | Reserved | | | | 0 |
| Bit 6 | | | Reserved | | | | | |
| Bit 5 | | | Reserved | | | | 0 | |
| Bit 4 | | | | Reserved | | | | 0 |
| Bit 3 | | | | Reserved | | | | 0 |
| Bit 2 | | | | Reserved | | | | 0 |
| Bit 1 | | | | Reserved | | | | 0 |
| Bit 0 | | | | Reserved | | | | 0 |

SMBusTable: Vendor & Revision ID Register

| Byte | 5 Pin # | Name | Control Function | Туре | 0 | 1 | Default |
|-------|---------|------|------------------|------|--------------|---|---------|
| Bit 7 | - | RID3 | | R | A rev = 0000 | | Х |
| Bit 6 | - | RID2 | REVISION ID | R | | | Х |
| Bit 5 | - | RID1 | REVISIONID | R | | | Х |
| Bit 4 | - | RID0 | | R | | | Х |
| Bit 3 | - | VID3 | | R | | | 0 |
| Bit 2 | - | VID2 | VENDOR ID | R | - | - | 0 |
| Bit 1 | - | VID1 | | R | - | - | 0 |
| Bit 0 | - | VID0 | | R | - | - | 1 |

SMBusTable: DEVICE ID

| Byte 6 | Pin # | Name | Control Function | Туре | 0 | 1 | Default |
|--------|-------|-------------------|------------------|------|-----------|------------|---------|
| Bit 7 | - | Device ID 7 (MSB) | | R | | | 1 |
| Bit 6 | - | | Device ID 6 | R | | | 1 |
| Bit 5 | - | | Device ID 5 | R | | | 1 |
| Bit 4 | - | Device ID 4 | | R | 1251 is 2 | 51 Decimal | 1 |
| Bit 3 | - | Device ID 3 | | R | or F | B Hex | 1 |
| Bit 2 | - | | Device ID 2 | R | | | 0 |
| Bit 1 | - | | Device ID 1 | R |] | | 1 |
| Bit 0 | - | | Device ID 0 | R | | | 1 |

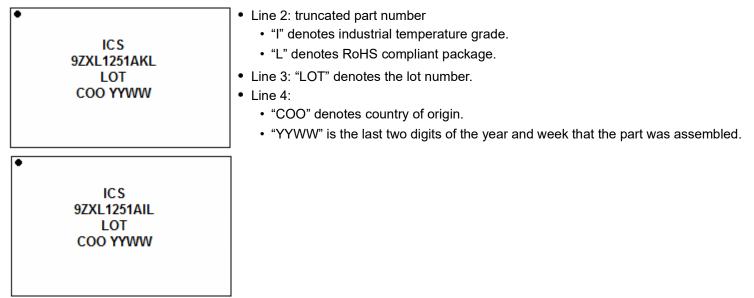
SMBusTable: Byte Count Register

| Byte | 7 | Pin # | Name | Control Function | Туре | 0 | 1 | Default | |
|-------|---|-------|----------|---|----------|------------------|---------|---------|--|
| Bit 7 | | | | Reserved | Reserved | | | | |
| Bit 6 | | | Reserved | | | | 0 | | |
| Bit 5 | | | | Reserved | | | 0 | | |
| Bit 4 | | - | BC4 | | RW | | | 0 | |
| Bit 3 | | - | BC3 | Writing to this register configures how | RW | Default value | 1 | | |
| Bit 2 | | - | BC2 | many bytes will be read back. | RW | bytes (0 to 8) w | 0 | | |
| Bit 1 | | - | BC1 | many bytes will be read back. | RW | by de | efault. | 0 | |
| Bit 0 | | - | BC0 | | RW | | | 0 | |

SMBusTable: Reserved Register

| Byte | e 8 | Pin # | Name | Control Function | Туре | 0 | 1 | Default | |
|-------|-----|-------|----------|------------------|------|---|---|---------|--|
| Bit 7 | | | | Reserved | | | | 0 | |
| Bit 6 | | | | Reserved | | | | | |
| Bit 5 | | | Reserved | | | | | 0 | |
| Bit 4 | | | Reserved | | | | | 0 | |
| Bit 3 | | | Reserved | | | | | 0 | |
| Bit 2 | | | | Reserved | | | | 0 | |
| Bit 1 | | | Reserved | | | | | | |
| Bit 0 | | | Reserved | | | | | | |

Marking Diagrams



Package Outline Drawings

The package outline drawings are appended at the end of this document. The package information is the most current data available.

Ordering Information

| Part / Order Number | Shipping Package | Package | Temperature |
|---------------------|------------------|---------------|--------------|
| 9ZXL1251AKLF | Trays | 64-pin VFQFPN | 0 to +70°C |
| 9ZXL1251AKLFT | Tape and Reel | 64-pin VFQFPN | 0 to +70°C |
| 9ZXL1251AKILF | Trays | 64-pin VFQFPN | -40 to +85°C |
| 9ZXL1251AKILFT | Tape and Reel | 64-pin VFQFPN | -40 to +85°C |

"LF" suffix to the part number denotes Pb-Free configuration, RoHS compliant.

"A" is the device revision designator (will not correlate with the datasheet revision).

Revision History

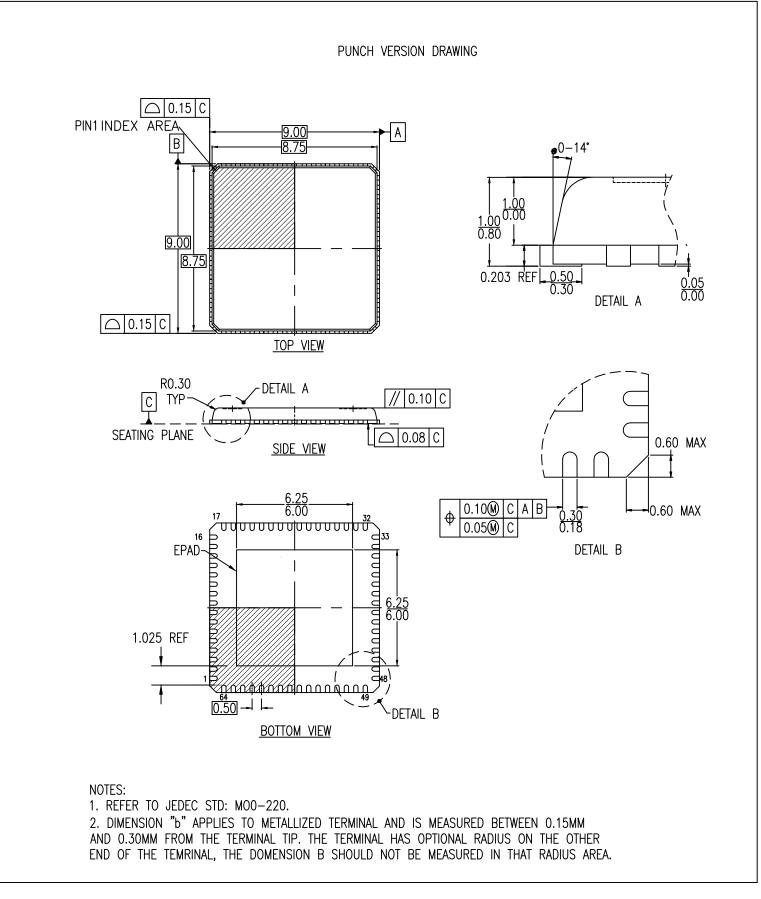
| Revision Date | Description |
|-------------------|--|
| July 23, 2015 | Update to final and Release |
| November 20, 2015 | Updated QPI references to QPI/UPI Updated DIF_IN table to match PCI SIG specification, no silicon change |
| January 28, 2021 | Updated input frequency minimum values from 33MHz to 25MHz. Added "25MHz PFT clock delay management" bullet to Features section on cover page. Reformatted headers and footers to Renesas. Updated Marking Diagram and Package Outline Drawings sections. |



64-VFQFPN, Package Outline Drawing

9.0 x 9.0 x 0.85 mm Body, 0.5mm Pitch, Epad 6.15 x 6.15 mm

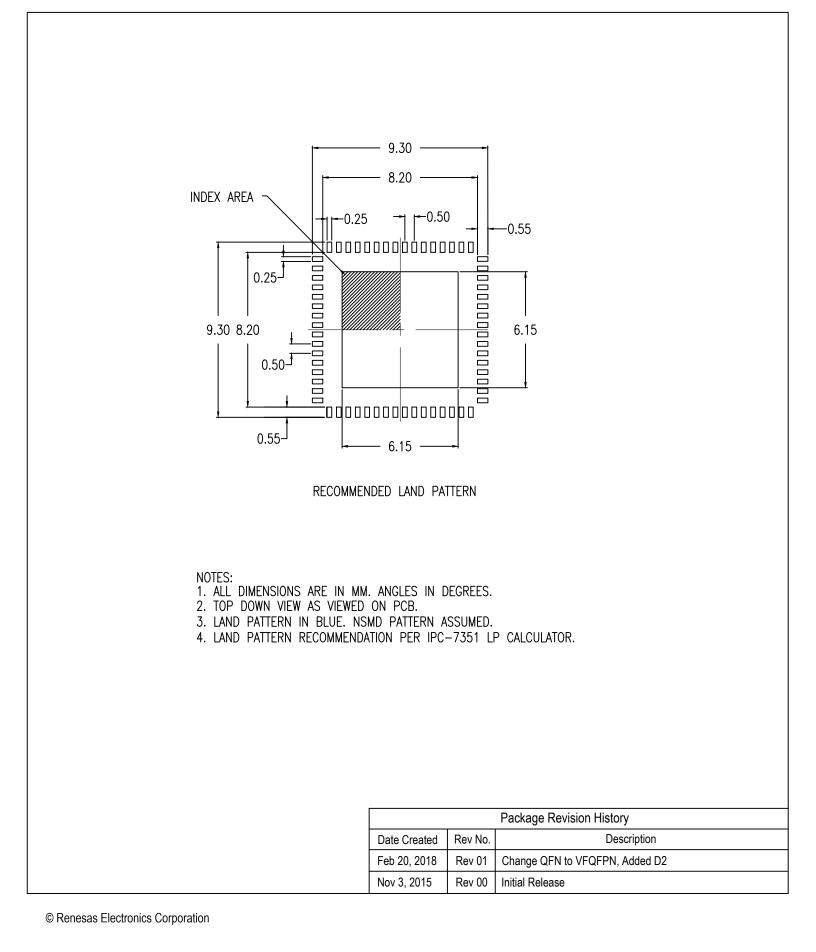
NLG64D2 Punch, PSC-4147-07, Rev 01, Page 1





64-VFQFPN, Package Outline Drawing

9.0 x 9.0 x 0.85 mm Body, 0.5mm Pitch, Epad 6.15 x 6.15 mm NLG64D2 Punch, PSC-4147-07, Rev 01, Page 2



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